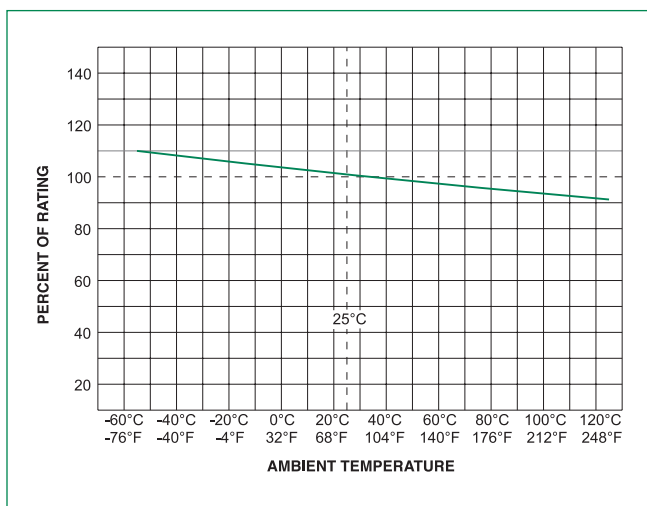
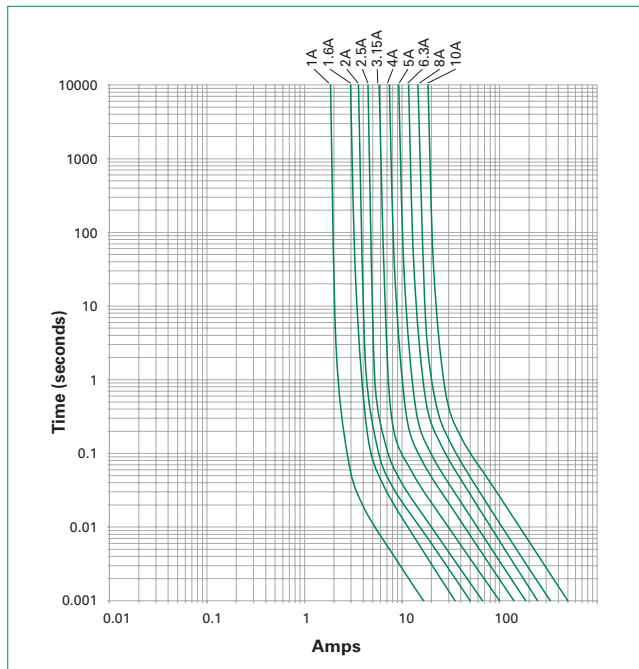


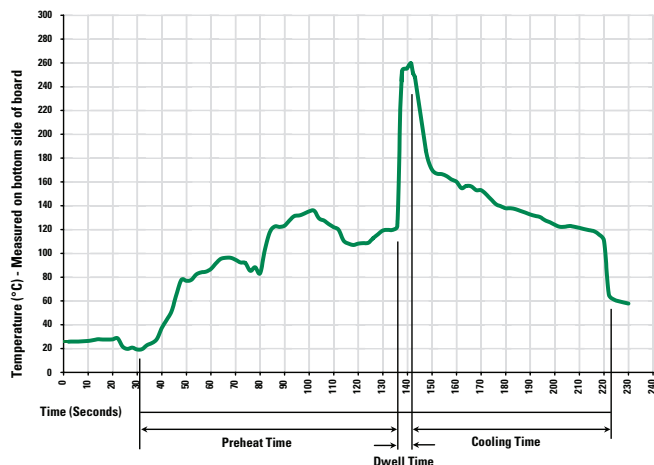
Temperature Re-rating Curve



Average Time Current Curves



Soldering Parameters - Wave Soldering



Recommended Process Parameters:

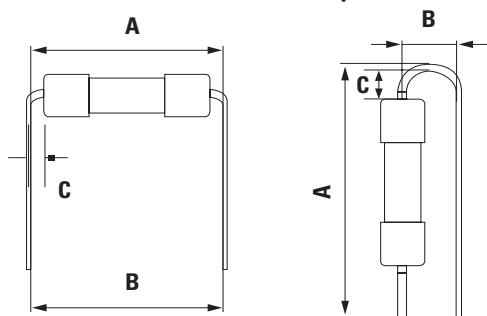
Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum:	100°C
Temperature Maximum:	150°C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	260°C Maximum
Solder Dwell Time:	2-5 seconds

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350°C +/- 5°C
Heating Time: 5 seconds max.

Note: These devices are not recommended for IR or Convection Reflow process.

Different values of A and B available, please contact the Littelfuse sales representative in your region:



For the pigtailed fuse, please follow the recommendations below for axial lead forming and mounting into PCB:

Lead forming:

The distance C between cap flat surface and axial lead shall be greater than 1.0 mm.

PCB mounting:

According to the standard of IPC-A-610, the distance between PCB and fuse cap is recommended to be a minimum of 1.5 mm.

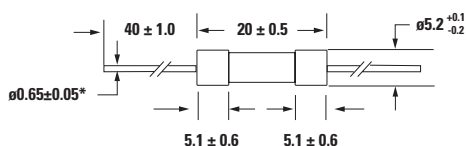
Product Characteristics

Materials	Body: Ceramic Cap: Nickel-plated Brass Leads: Tin-plated Copper
Terminal Strength	MIL-STD-202, Method 211, Test Condition A
Solderability	MIL-STD-202 Method 208
Product Marking	Cap 1: Brand logo, current and voltage ratings Cap 2: Agency approval marks

Operating Temperature	–55°C to +125°C
Thermal Shock	MIL-STD-202, Method 107, Test Condition B (5 cycles, –65°C to +125°C)
Vibration	MIL-STD-202, Method 201
Humidity	MIL-STD-202, Method 103, Test Condition A (High RH (95%) and elevated temp (40°C) for 240 hours)
Salt Spray	MIL-STD-202, Method 101, Test Condition B

Dimensions

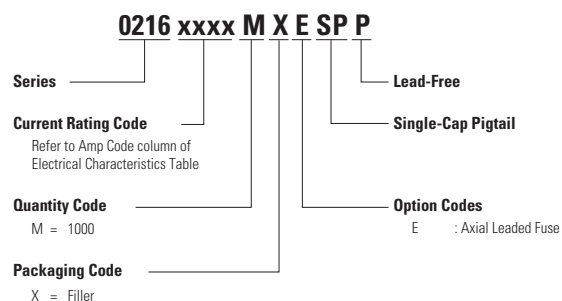
All dimensions in mm



Notes:

* Ratings 8A and 10A have 0.8 ± 0.05 diameter lead.

Part Numbering System



Packaging

Packaging Option	Packaging Specification	Quantity	Packaging Code	Reel Size
216SP Series				
Bulk	N/A	1000	MXE	N/A